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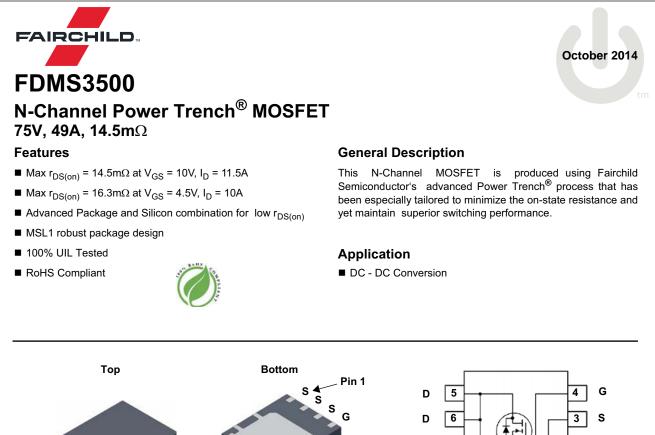


# **ON Semiconductor**®

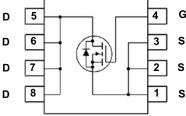
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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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FDMS3500 N-Channel Power Trench<sup>®</sup> MOSFET

## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

D

D n

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			75	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25°C		49		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25°C		57		
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	9.2	— A	
	-Pulsed			100		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	384	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		96	W	
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	l) 50	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3500	FDMS3500	Power 56	13"	12mm	3000 units

1

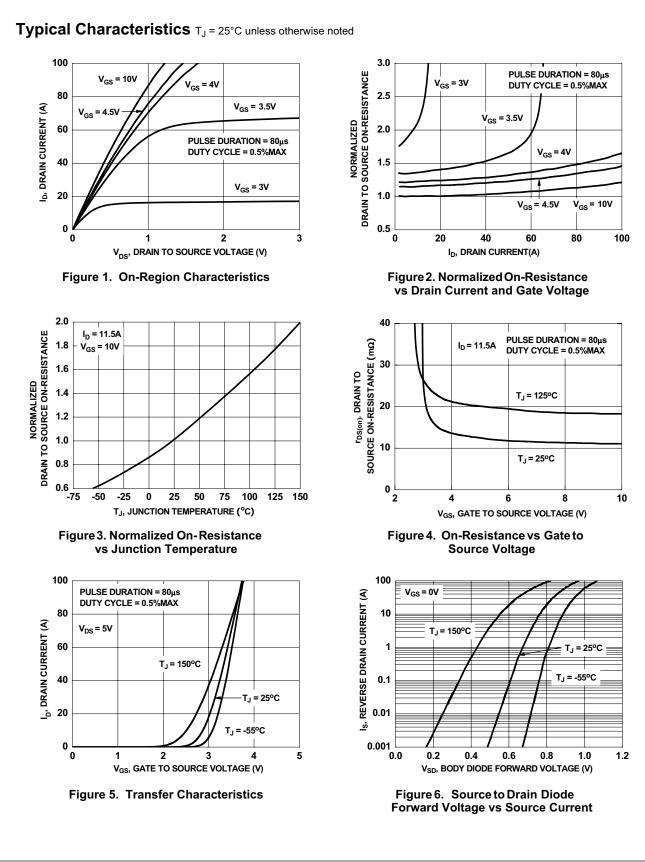
$\frac{\Delta BV_{DSS}}{\Delta T_J}$ $\frac{I_{DSS}}{I_{GSS}}$	Cteristics         Drain to Source Breakdown Voltage         Breakdown Voltage Temperature         Coefficient         Zero Gate Voltage Drain Current	$I_D$ = 250µA, V <sub>GS</sub> = 0V $I_D$ = 250µA, referenced to 25°C				
$\frac{\Delta BV_{DSS}}{\Delta T_J}$ $\frac{I_{DSS}}{I_{GSS}}$	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current					
$\frac{\Delta BV_{DSS}}{\Delta T_J}$ $I_{DSS}$ $I_{GSS}$	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current		75			V
ΔT <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub>	Coefficient Zero Gate Voltage Drain Current	I <sub>D</sub> = 250μA, referenced to 25°C				-
I <sub>GSS</sub>	-			71		mV/°C
		V <sub>GS</sub> = 0V, V <sub>DS</sub> = 60V,			1	μA
0	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA	1.0	1.8	3.0	V
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage		1.0	1.0	5.0	v
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		-6.8		mV/°0
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 11.5A		11.1	14.5	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 10A$		12.8	16.3	
		$V_{GS} = 10V, I_D = 11.5A, T_J = 125^{\circ}C$		17.6	23.0	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 5V, I_D = 11.5A$		56		S
			1			
-	Characteristics					
C <sub>iss</sub>	Input Capacitance	$-V_{DS} = 40V, V_{GS} = 0V,$		3580	4765	pF
C <sub>oss</sub>	Output Capacitance	-f = 1MHz		225	300	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			120	175	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		1.2		Ω
Switching	g Characteristics					
	<b>Characteristics</b>			16	29	ns
t <sub>d(on)</sub>	-			16 9	29 18	1
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	V <sub>DD</sub> = 40V, I <sub>D</sub> = 11.5A,				ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time			9	18	ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Turn-On Delay Time Rise Time Turn-Off Delay Time	V <sub>DD</sub> = 40V, I <sub>D</sub> = 11.5A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		9 48	18 77	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 40V, I_D = 11.5A,$ $V_{GS} = 10V, R_{GEN} = 6Ω$ $V_{GS} = 0V \text{ to } 10V$		9 48 6	18 77 11	ns ns ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	V <sub>DD</sub> = 40V, I <sub>D</sub> = 11.5A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		9 48 6 65	18 77 11 91	ns ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{DD} = 40V, I_{D} = 11.5A, V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V V_{DD} = 40V,$		9 48 6 65 34	18 77 11 91	ns ns ns nC nC
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{DD} = 40V, I_{D} = 11.5A, V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V V_{DD} = 40V,$		9 48 6 65 34 9.9	18 77 11 91	ns ns ns nC nC
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{DD} = 40V, I_{D} = 11.5A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 40V,$ $I_{D} = 11.5A$		9 48 6 65 34 9.9 11.6	18 77 11 91 48	ns ns ns nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sou</b>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{DD} = 40V, I_{D} = 11.5A, V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V V_{DD} = 40V, I_{D} = 11.5A$ $V_{GS} = 0V, I_{S} = 11.5A \text{ (Note 2)}$		9 48 6 65 34 9.9 11.6	18 77 11 91 48 	ns ns ns nC nC
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$ $Q_{gd}$ <b>Drain-Sou</b> $V_{SD}$	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage	$V_{DD} = 40V, I_{D} = 11.5A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 40V,$ $I_{D} = 11.5A$		9 48 6 65 34 9.9 11.6 0.8 0.7	18 77 11 91 48 	ns ns ns nC nC nC nC v
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{DD} = 40V, I_{D} = 11.5A, V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V V_{DD} = 40V, I_{D} = 11.5A$ $V_{GS} = 0V, I_{S} = 11.5A \text{ (Note 2)}$		9 48 6 65 34 9.9 11.6	18 77 11 91 48 	ns ns ns nC nC nC

2. Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

3. Starting T<sub>J</sub> = 25°C, L = 3mH, I<sub>AS</sub> = 16A, V<sub>DD</sub> = 75V, V<sub>GS</sub> = 10V

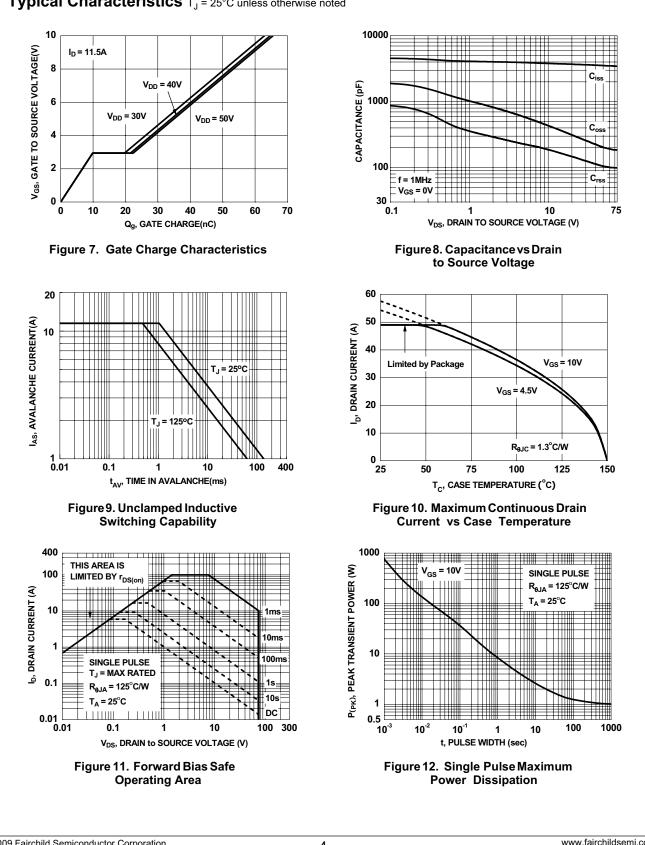
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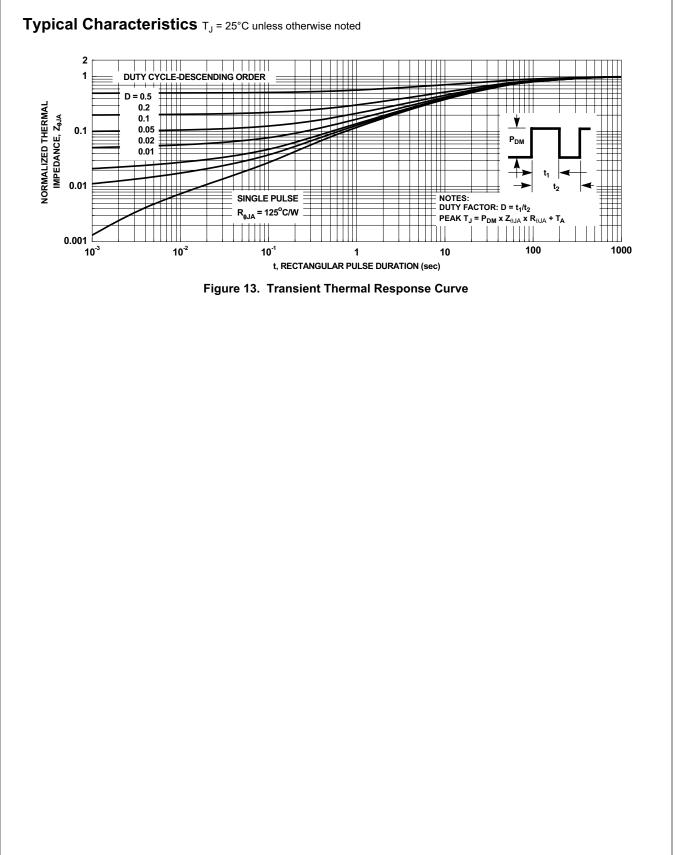


## Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

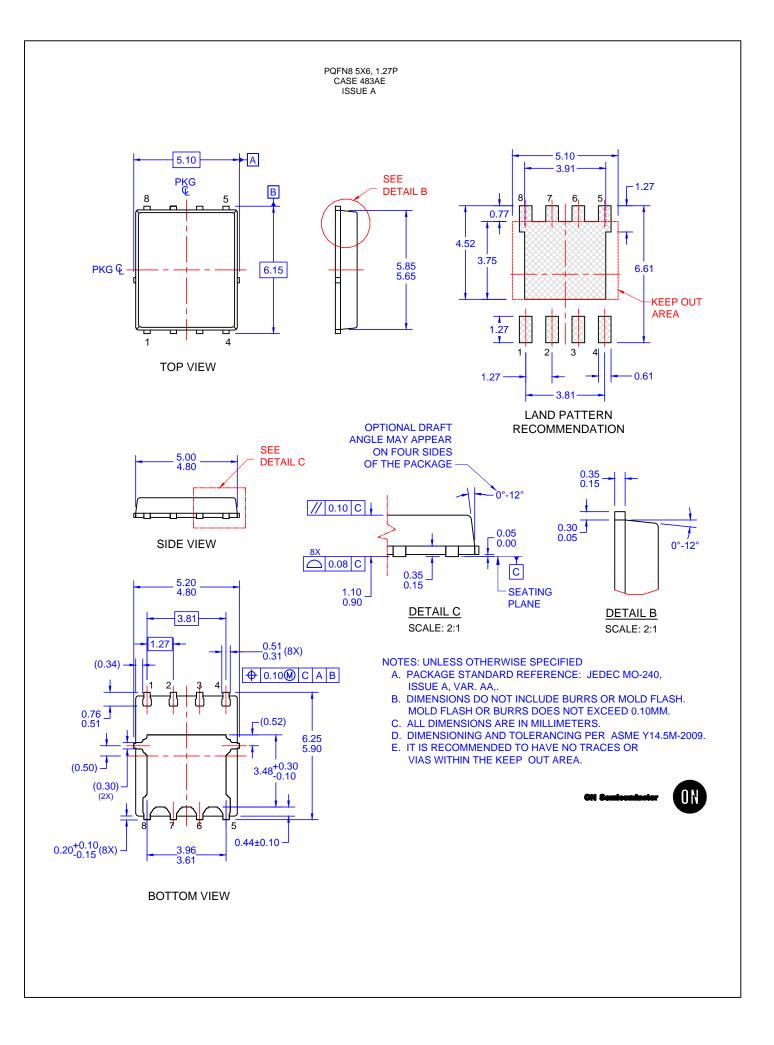
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